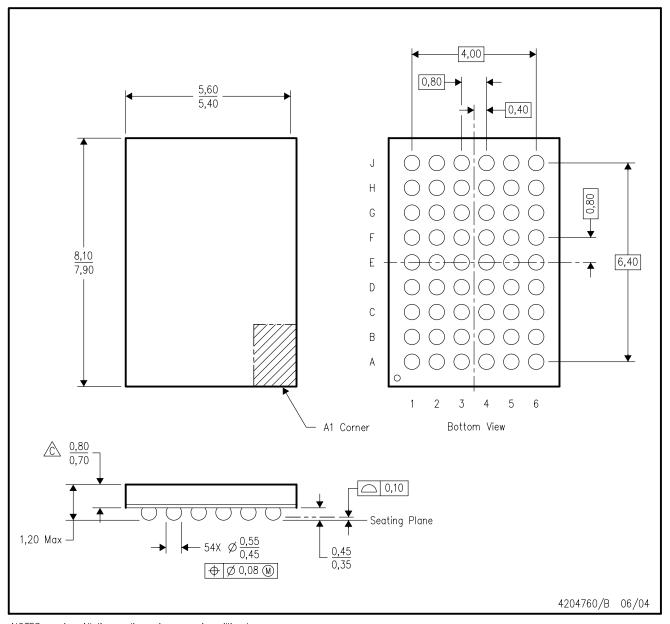
ZRD (R-PBGA-N54)

PLASTIC BALL GRID ARRAY



 $\hbox{NOTES:} \quad \hbox{A. All linear dimensions are in millimeters.}$

- B. This drawing is subject to change without notice.
- Falls within JEDEC MO-205 variation DD.
- D. This package is lead—free. Refer to the 54 GRD package (drawing 4204759) for tin—lead (SnPb).



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